

## **REPLACEMENT SHEET**

ATTY Dkt. No.: APPM/005975.P2/CPI/L/B/P.JS

U.S. SERIAL No.: 10/811,230

FILED: MARCH 26, 2004

**TITLE:**

## RUTHENIUM LAYER FORMATION FOR COPPER FILM DEPOSITION

CONF. NO.: 8995

## FILM DEPOSITION RACE 3.055

PAGE 2 OF 5

2/5

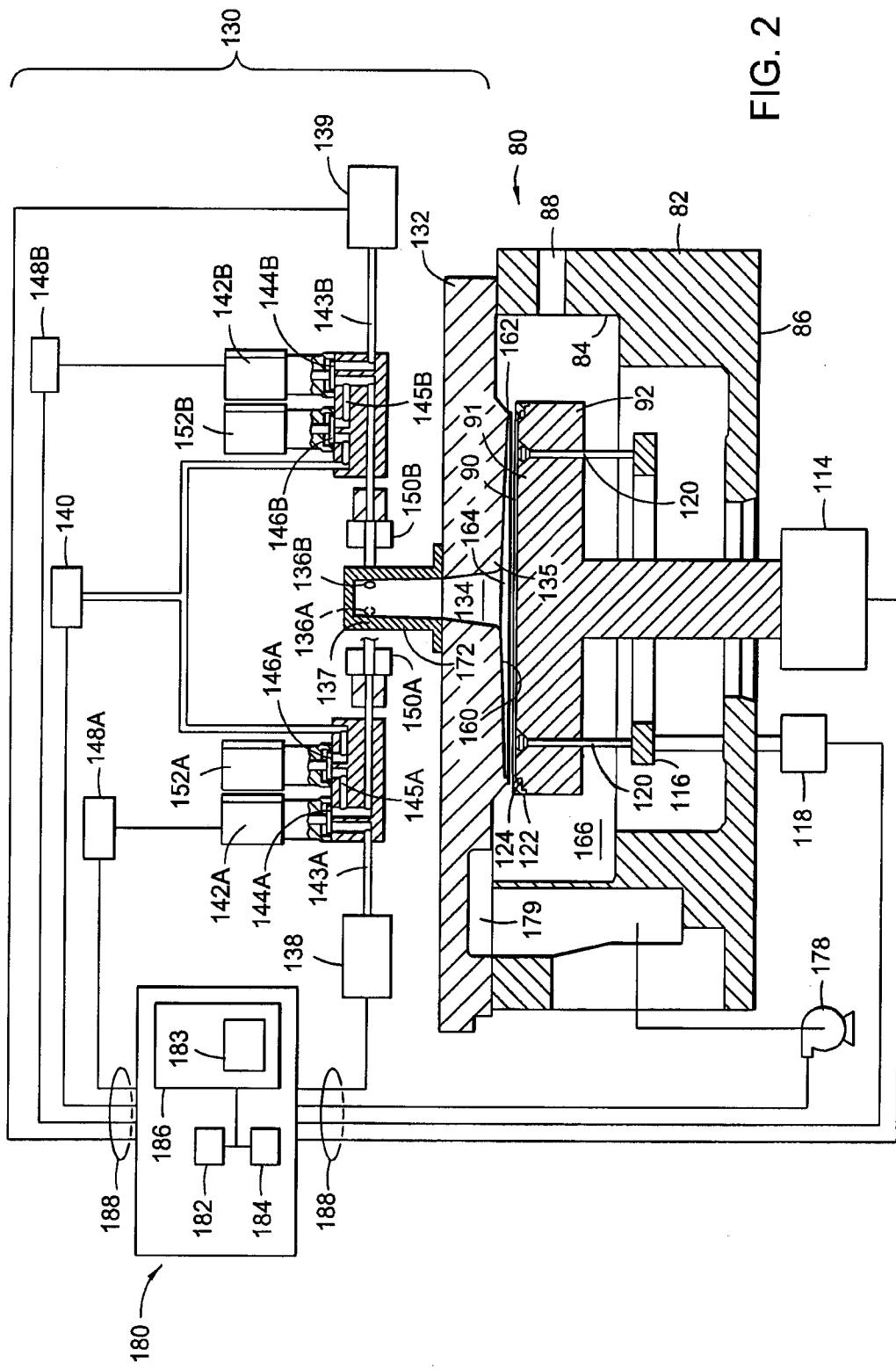


FIG. 2